

SPK0641HT4H-1 Rev A Datasheet

# Digital SiSonic<sup>™</sup> Microphone With Multiple Performance Modes

The SPK0641HT4H-1 is a miniature, high-performance, low power, top port silicon digital microphone with a single-bit PDM output. Using Knowles' proven high performance SiSonic<sup>TM</sup> MEMS technology, the SPK0641HT4H-1 consists of an acoustic sensor, a low noise input buffer, and a sigma-delta modulator. These devices are suitable for applications such as cellphones, smart phones, laptop computers, sensors, digital still cameras, portable music recorders, and other portable electronic devices where excellent wideband audio performance and RF immunity are required. The high Signal-to-Noise Ratio (SNR) of the SPK0641HT4H-1 enhances the performance of far-field applications and many complex, multi-microphone algorithms. In addition, the SPK0641HT4H-1 offers multiple performance modes.

#### **Product Features**

- Low Distortion of 2.2% at 115dB SPL
- Signal-to-Noise Ratio of 64.5dB(A)
- Flat Frequency Response 20 20kHz
- High Drive Capability
- Low Current Consumption of 230uA in Low-Power Mode
- RF Shielded

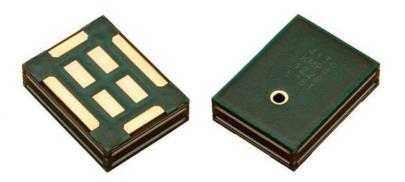
## **Typical Applications**

- Portable electronics
- Cellphones
- Laptop Computers

- PDM Output
- Supports Dual Multiplexed Channels

SPK0641HT4H-1

- Ultra-Stable Performance
- Standard SMD Reflow
- Omnidirectional
- Sensitivity Matching
- Standard 4x3x1 package size
- Tablets
- Digital Still Cameras
- Portable Music Recorders



## **Absolute Maximum Ratings**

| Table 1: Absolute Maximi | um Ratings              |       |                            |                             |       |
|--------------------------|-------------------------|-------|----------------------------|-----------------------------|-------|
| Parameter                | Absolute Maximum Rating | Units | Parameter                  | Absolute Maximum Rating     | Units |
| Vdd, DATA to Ground      | -0.3, +5.0              | V     | Input Current              | ±5                          | mA    |
| CLOCK to Ground          | -0.3, +5.0              | V     | Short Circuit to/from DATA | Indefinite to Ground or Vdd | sec   |
| SELECT to Ground         | -0.3, +5.0              | V     | Temperature                | -40 to +100                 | °C    |

Stresses exceeding these "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation at these or any other conditions beyond those indicated under "Acoustic & Electrical Specifications" is not implied. Exposure beyond those indicated under "Acoustic & Electrical Specifications" for extended periods may affect device reliability.

# Acoustic & Electrical Specifications<sup>1</sup>

#### Table 2: General Microphone Specifications Test Conditions: 23±2°C, 55±20% R.H., Vdd=1.8V, Fclock=2.4MHz, SEL grounded, no load, Tedge<3ns unless otherwise indicated

| Parameter                       | Symbol | Conditions                | Min                       | Тур   | Max         | Units |
|---------------------------------|--------|---------------------------|---------------------------|-------|-------------|-------|
| Supply Voltage                  | Vdd    |                           | 1.6                       | 1.8   | 3.6         | V     |
| DC Output                       |        | Fullscale = $\pm 100$     | -                         | 0     | -           | % FS  |
| Directivity                     |        |                           |                           | Omnio | directional |       |
| Polarity                        |        | Increasing sound pressure | Increasing density of 1's |       |             | 6     |
| Data Format                     |        |                           | 1/2 Cycle PDM             |       |             |       |
| Short Circuit Current           | lsc    | Grounded DATA pin         | 1                         | -     | 20          | mA    |
| Output Load                     | Cload  |                           | -                         | -     | 140         | pF    |
| Fall-asleep Time <sup>3,4</sup> |        | Fclock < 250 kHz          | -                         | -     | 10          | ms    |
| Wake-up Time <sup>3,5</sup>     |        | Fclock ≥ 350kHz           | -                         | -     | 15          | ms    |
| Power-up Time <sup>3</sup>      |        | Vdd ≥ V(min)              | -                         | -     | 50          | ms    |
| Mode Change Time <sup>3</sup>   |        |                           | -                         | -     | 10          | ms    |

#### Table 3: Performance Mode Microphone Specifications

| Test Conditions: 23±2°C, 55±20% R.H., Vdd=1.8V, Fclock=2.4MHz, SEL grounded, no load, Tedge<3ns unless otherwise indicated |         |   |       |      |       |         |
|--|---------|---|-------|------|-------|---------|
| Parameter  | Symbol  | Conditions                                  | Min   | Тур  | Max   | Units   |
| Clock Frequency  | Fclock  |   | 1.000 | -    | 4.800 | MHz     |
| Supply Current <sup>2</sup>  | ldd     | Vdd = 1.8V                                  | -     | 630  | 710   | μA      |
| Supply Current <sup>2</sup>  | ldd     | Vdd = 3.6V                                  | -     | 700  | 800   | μA      |
| Sensitivity  | S       | 94 dB SPL @ 1 kHz                           | -27   | -26  | -25   | dBFS    |
| Sensitivity Drop   |         | Vdd(min) < Vdd < Vdd(max)                   | -     | -    | ±0.25 | dB      |
| Signal to Noise Ratio  | SNR     | 94 dB SPL @ 1 kHz, A-weighted               | -     | 64.5 | -     | dB(A)   |
| Total Harmonic Distortion  | THD     | 94 dB SPL @ 1 kHz, S = Typ                  | -     | 0.1  | -     | %       |
| Total Harmonic Distortion  | THD     | 115 dB SPL @ 1 kHz, S = Typ                 | -     | 2.2  | -     | %       |
| Acoustic Overload Point  | AOP     | 10% THD @ 1 kHz, S = Typ                    | -     | 120  | -     | dB SPL  |
| Low Frequency Roll-Off   | LFRO    | 3 dB below 1 kHz Sensitivity                | -     | 35   | -     | Hz      |
| Power Supply Rejection<br>Ratio  | PSRR    | 200 mVpp sinewave @ 1 kHz                   | -     | 70   | -     | dBV/FS  |
| Power Supply Rejection   | PSR + N | 100mVpp square wave<br>@ 217 Hz, A-weighted | -     | -90  | -     | dBFS(A) |

#### Table 4: Low-Power Mode Microphone Specifications

Test Conditions: 23±2°C, 55±20% R.H., Vdd=1.8V, Fclock=768kHz, SEL grounded, no load, Tedge<3ns unless otherwise indicated

| Parameter                       | Symbol  | Conditions                                       | Min | Тур | Max   | Units   |
|---------------------------------|---------|--|-----|-----|-------|---------|
| Clock Frequency                 | Fclock  |  | 350 | -   | 800   | kHz     |
| Supply Current <sup>2</sup>     | ldd     | Vdd = 1.8V                                       | -   | 230 | 275   | μA      |
| Supply Current <sup>2</sup>     | ldd     | Vdd = 3.6V                                       | -   | 270 | 330   | μA      |
| Sensitivity                     | S       | 94 dB SPL @ 1 kHz                                | -27 | -26 | -25   | dBFS    |
| Sensitivity Drop                |         | Vdd(min) < Vdd < Vdd(max)                        | -   | -   | ±0.25 | dB      |
| Signal to Noise Ratio           | SNR     | 94 dB SPL @ 1 kHz,<br>A-weighted (20 Hz – 8 kHz) | -   | 64  | -     | dB(A)   |
| Total Harmonic Distortion       | THD     | 94 dB SPL @ 1 kHz, S = Typ                       | -   | 0.2 | -     | %       |
| Acoustic Overload Point         | AOP     | 10% THD @ 1 kHz, S = Typ                         | -   | 120 | -     | dB SPL  |
| Low Frequency Roll-Off          | LFRO    | 3 dB below 1 kHz Sensitivity                     | -   |     | -     | Hz      |
| Power Supply Rejection<br>Ratio | PSRR    | 200 mVpp sinewave @ 1 kHz                        | -   | 75  | -     | dBV/FS  |
| Power Supply Rejection          | PSR + N | 100mVpp square wave<br>@ 217 Hz, A-weighted      | -   | -91 | _     | dBFS(A) |

#### Table 5: Sleep Mode Microphone Specifications

Test Conditions: 23±2°C, 55±20% R.H., Vdd=1.8V, Fclock<250kHz, SEL grounded, Tedge<3ns, no load, unless otherwise indicated

| Parameter       | Symbol | Conditions                | Min | Тур | Max | Units |
|-----------------|--------|---------------------------|-----|-----|-----|-------|
| Clock Frequency | Fclock |                           | 0   | -   | 250 | kHz   |
| Sleep Current   | Isleep | Fclock = 0 Hz, Vdd = 1.8V | -   | 26  | -   | μA    |
| Sleep Current   | Isleep | Fclock = 0 Hz, Vdd = 3.6V | -   | 26  | -   | μA    |

#### Table 6: Microphone Interface Specifications

| Parameter                         | Symbol | Conditions              | Min      | Тур | Max      | Units |
|-----------------------------------|--------|-------------------------|----------|-----|----------|-------|
| Logic Input High                  | Vih    |                         | 0.7xVdd  | -   | 3.6      | V     |
| Logic Input Low                   | Vil    |                         | -0.3     | -   | 0.3xVdd  | V     |
| Low→High Threshold                | VI-h   |                         | 0.55xVdd |     | 0.7xVdd  | V     |
| High→Low Threshold                | Vh-I   |                         | 0.3xVdd  |     | 0.45xVdd | V     |
| Hysteresis Width                  | Vhyst  |                         | 0.1xVdd  | -   | 0.29xVdd | V     |
| Logic Output High                 | Voh    | I <sub>OUT</sub> = 2 mA | Vdd-0.45 | -   | -        | V     |
| Logic Output Low                  | Vol    | I <sub>OUT</sub> = 2 mA | -        | -   | 0.45     | V     |
| SELECT (high)                     |        |                         | 0.7xVdd  | -   | 3.6      | V     |
| SELECT (low)                      |        |                         | -0.3     | -   | 0.3xVdd  | V     |
| Clock Duty Cycle                  |        |                         | 40       | -   | 60       | %     |
| Clock Rise/Fall Time              | Tedge  |                         | -        | -   | 13       | ns    |
| Delay Time to Data Line<br>Driven | Tdd    |                         | 18       | -   | -        | ns    |
| Delay Time to High Z <sup>6</sup> | Tdz    |                         | 3        | -   | 16       | ns    |

<sup>1</sup> Sensitivitiy and Supply Current are 100% tested.

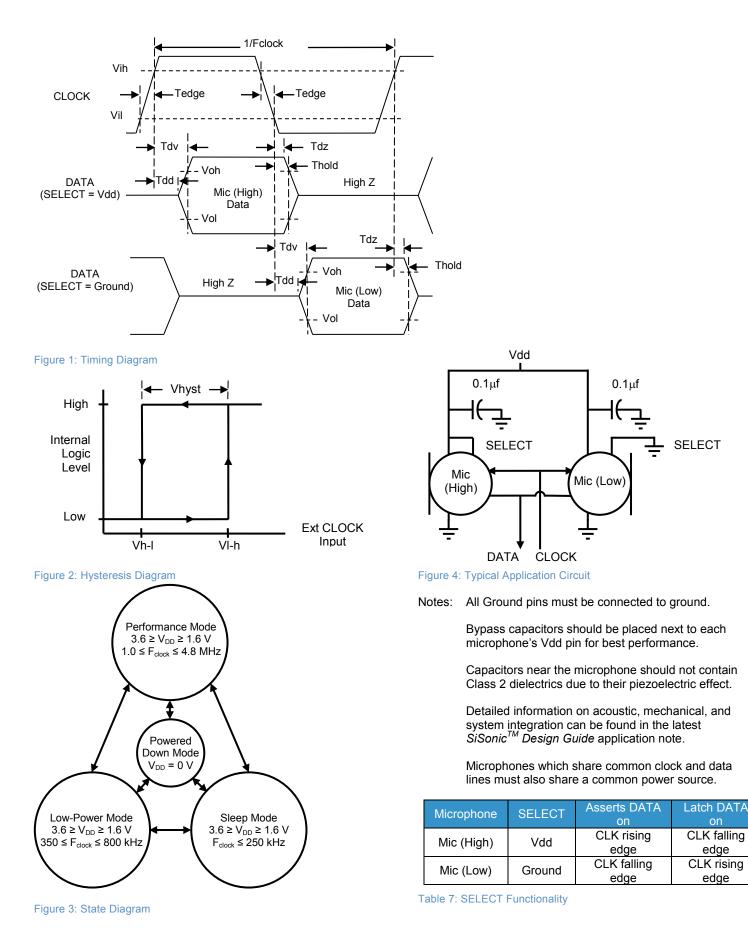
<sup>2</sup> Idd varies with Cload according to:  $\Delta$ Idd = 0.5\*Vdd\* $\Delta$ Cload\*Fclock.

<sup>3</sup> Valid microphones states are: Powered Down Mode (mic off), Sleep Mode (low current, DATA = high-Z, fast startup), Low-Power Mode (low clock speed) and Performance Mode (normal operation)

<sup>4</sup> Time from Fclock < 250 kHz to Isleep specification is met when transitioning from Active Mode to Sleep Mode.

Time from Fclock  $\geq$  350kHz to all applicable specifications are met when transitioning from Sleep Mode to Active Mode.

<sup>6</sup> Thold is dependent on Cload.



#### **Performance Curves**

Test Conditions: Vdd=1.8V, Fs = 2.4MHz, no load, unless otherwise indicated

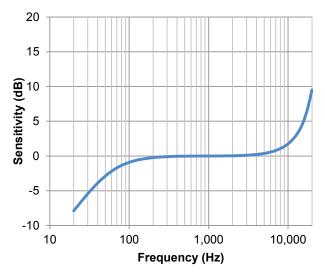


Figure 5: Typical Free Field Response Normalized to 1 kHz

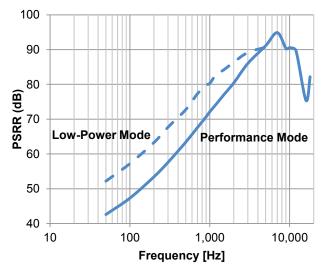
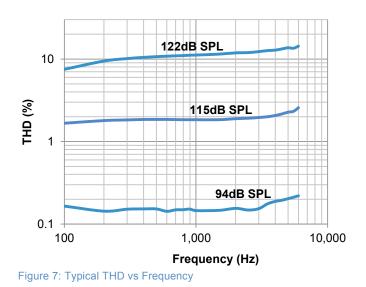


Figure 6: Typical PSRR



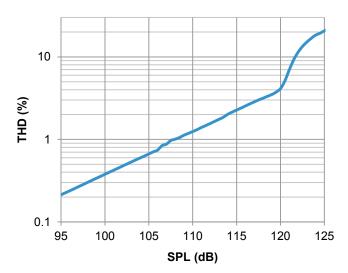


Figure 8: Typical THD vs SPL

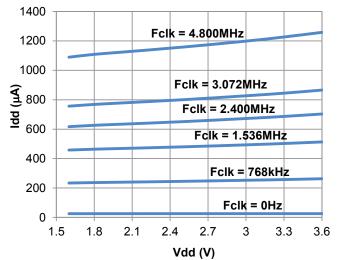


Figure 9: Typical Free Field Response Normalized to 1 kHz

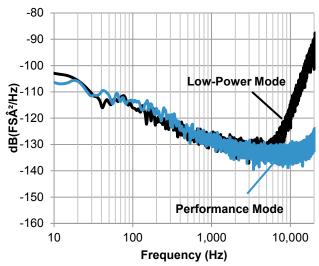
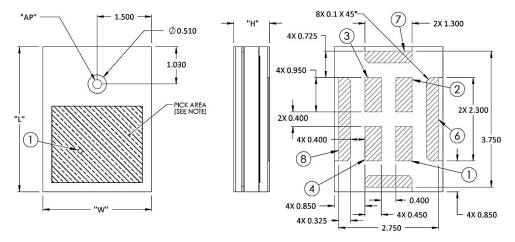


Figure 10: Typical Microphone Noise Floor

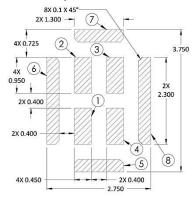
## **Mechanical Specifications**



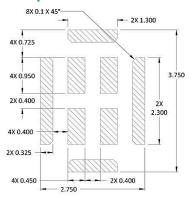
| tem                | Dimension | Tolerance |
|--------------------|-----------|-----------|
| Length (L)         | 4.00      | ±0.10     |
| Width (W)          | 3.00      | ±0.10     |
| Height (H)         | 1.00      | ±0.10     |
| Acoustic Port (AP) | Ø0.25     | ±0.05     |

| Pin # | Pin Name | Туре              | Description   |  |  |
|-------|----------|-------------------|---|--|--|
| 1     | DATA     | Digital O         | PDM Output  |  |  |
| 2     | CLOCK    | Digital I         | Clock Input   |  |  |
| 3     | SELECT   | Non-Digital Input | Lo/Hi (L/R) Select. This pin is internally pulled low |  |  |
| 4     | Vdd      | Power             | Power Supply  |  |  |
| 5     | GROUND   | Power             | Ground  |  |  |
| 6     | GROUND   | Power             | Ground  |  |  |
| 7     | GROUND   | Power             | Ground  |  |  |
| 8     | GROUND   | Power             | Ground  |  |  |

#### **Example Land Pattern**



#### **Example Solder Stencil Pattern**





Notes:

Pick Area only extends to 0.25 mm of any edge or hole unless otherwise specified.

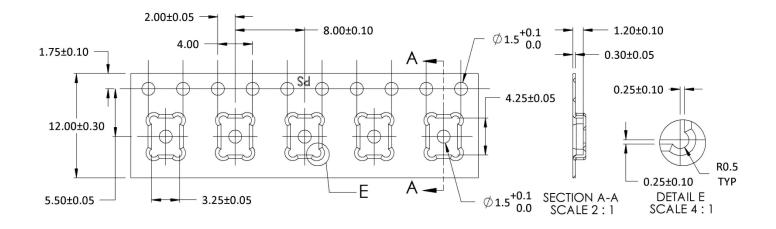
Dimensions are in millimeters unless otherwise specified.

Tolerance is ±0.15mm unless otherwise specified

In the acoustic path, the recommended Gasket Cavity Diameter is  $D \ge 1.0$ mm and the recommended Case Hole Diameter is  $1.0 \le D \le 1.5$ mm. More information on AP size considerations can be found in the latest *SiSonic<sup>TM</sup> Design Guide* application note.

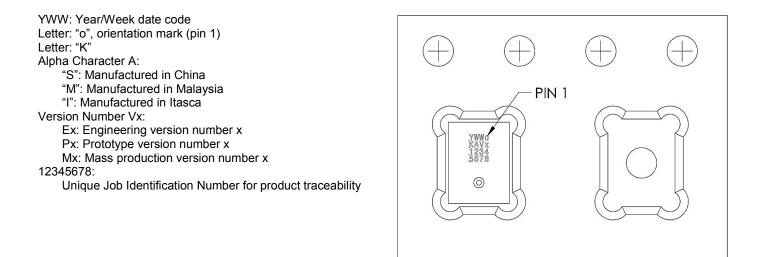
Further optimizations based on application should be performed.

## **Packaging & Marking Detail**



| Model Number  | Suffix | Reel Diameter | Quantity Per Reel |
|---------------|--------|---------------|-------------------|
| SPK0641HT4H-1 | -7     | 13"           | 5,700             |

| Component    | Surface Resistance (ohms)          |
|--------------|------------------------------------|
| Reel         | 10 <sup>5</sup> - 10 <sup>9</sup>  |
| Carrier Tape | 10 <sup>5</sup> - 10 <sup>9</sup>  |
| Cover Tape   | 10 <sup>4</sup> - 10 <sup>10</sup> |



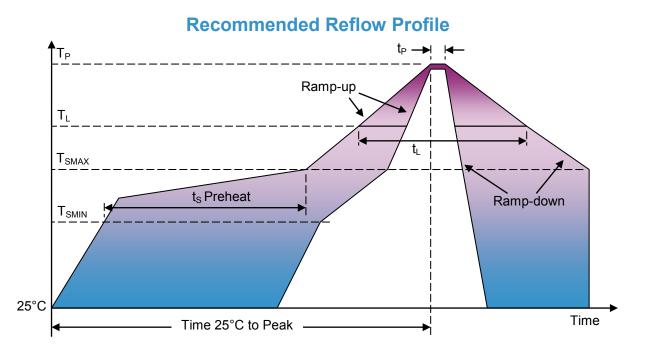
Notes: Dimensions are in millimeters unless otherwise specified.

Vacuum pickup only in the pick area indicated in Mechanical Specifications.

Tape & reel per EIA-481 Rev C.

Labels applied directly to reel and external package.

Shelf life: Twelve (12) months when devices are to be stored in factory supplied, unopened ESD moisture sensitive bag under maximum environmental conditions of 30°C, 70% R.H.



| Profile Feature   | Pb-Free         |
|---|-----------------|
| Average Ramp-up rate (T <sub>SMAX</sub> to T <sub>P</sub> )                     | 3°C/second max. |
| Preheat   |                 |
| <ul> <li>Temperature Min (T<sub>SMIN</sub>)</li> </ul>                          | 150°C           |
| <ul> <li>Temperature Max (T<sub>SMAX</sub>)</li> </ul>                          | 200°C           |
| <ul> <li>Time (T<sub>SMIN</sub> to T<sub>SMAX</sub>) (t<sub>s</sub>)</li> </ul> | 60-180 seconds  |
| Time maintained above:  |                 |
| Temperature (T <sub>L</sub> )   | 217°C           |
| • Time (t <sub>L</sub> )  | 60-150 seconds  |
| Peak Temperature (T <sub>P</sub> )  | 260°C           |
| Time within 5°C of actual Peak Temperature ( $t_P$ )                            | 20-40 seconds   |
| Ramp-down rate (T <sub>P</sub> to T <sub>SMAX</sub> )                           | 6°C/second max  |
| Time 25°C to Peak Temperature   | 8 minutes max   |

Notes: Based on IPC/JDEC J-STD-020 Revision C. All temperatures refer to topside of the package, measured on the package body surface

## **Additional Notes**

- (A) MSL (moisture sensitivity level) Class 1.
- (B) Maximum of 3 reflow cycles is recommended.
- (C) In order to minimize device damage:
  - Do not board wash or clean after the reflow process.
  - Do not brush board with or without solvents after the reflow process.
  - Do not directly expose to ultrasonic processing, welding, or cleaning.
  - Do not insert any object in port hole of device at any time.
  - Do not apply over 30 psi of air pressure into the port hole.
  - Do not pull a vacuum over port hole of the microphone.
  - Do not apply a vacuum when repacking into sealed bags at a rate faster than 0.5 atm/sec.

## **Materials Statement**

Meets the requirements of the European RoHS directive 2011/65/EC as amended.

Meets the requirements of the industry standard IEC 61249-2-21:2003 for halogenated substances and Knowles Green Materials Standards Policy section on Halogen-Free.

Product is Beryllium Free according to limits specified on the Knowles Hazardous Material List (HSL for Products).

Ozone depleting substances are not used in the product or the processes used to make the product, including compounds listed in Annex A, B, and C of the "Montreal Protocol on Substances That Deplete the Ozone Layer."

### **Reliability Specifications**

| Test                      | Description  |
|---------------------------|--|
| Thermal Shock             | 100 cycles of air-air thermal shock from -40°C to +125°C with 15 minute soaks (IEC 68-2-4)                                     |
| High Temperature Storage  | +105°C environment for 1,000 hours (IEC 68-2-2 Test Ba)  |
| Low Temperature Storage   | -40°C environment for 1,000 hours (IEC 68-2-2 Test Aa)   |
| High Temperature Bias     | +105°C environment while under bias for 1,000 hours (IEC 68-2-2 Test Ba)   |
| Low Temperature Bias      | -40°C environment while under bias for 1,000 hours (IEC 68-2-2 Test Aa)  |
| Temperature/Humidity Bias | +85°C/85% R.H. environment while under bias for 1,000 hours (JESD22-A101A-B)   |
| Vibration                 | 12 minutes in each axis from 20 to 2,000 Hz in X,Y, and Z directions with peak acceleration of 20g (MIL 883E, Method 2007.2,A) |
| ESD-LID/GND               | 3 discharges of ±8 kV direct contact to lid while unit is grounded.<br>(IEC 61000-4-2)   |
| ESD-MM                    | 3 discharges of ±200V direct contact to I/O pins.<br>(ESD STM5.2)  |
| Reflow                    | 5 reflow cycles with peak temperature of +260°C  |
| Tumble test               | 200 tumbles in 100g block from a height of 1m onto a steel base  |
| Mechanical Shock          | 3 pulses of 10,000g in each of the $\pm X$ , $\pm Y$ , $\pm Z$ directions while under bias (IEC 68-2-27 Test Ea)               |

Notes: After 3 reflow cycles, the sensitivity of the microphones shall not deviate more than 1dB from their initial value.

## **Specification Revisions**

| Revision | Specification Changes        | Date      |
|----------|------------------------------|-----------|
| А        | Initial Release (ECR 16-704) | 4/12/2016 |
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